

C0603C202FATAC7411

SMD Comm X8G HT150C, Ceramic, 2,000 pF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Sp
Chip Size	0603	Ca
L	1.6mm +/-0.15mm	Me
W	0.8mm +/-0.15mm	То
т	0.85mm +/-0.07mm	Vo
S	0.5mm MIN	Die
В	0.35mm +/-0.15mm	Те
		Τe

Packaging Specifications Packaging

Packaging Quantity

> T&R, 330mm, Paper Tape 10000

Specifications	
Capacitance	2,000 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	1%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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